3.3V CMOS OCTAL BUS TRANSCEIVER AND REGISTER WITH 3-STATE OUTPUTS AND 5 VOLT TOLERANT I/O

IDT74LVC652A

FEATURES:

- 0.5 MICRON CMOS Technology
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- 1.27mm pitch SOIC, 0.65mm pitch SSOP, 0.635mm pitch QSOP, 0.65mm pitch TSSOP packages
- Extended commercial range of – 40°C to +85°C
- V_{CC} = 3.3V ±0.3V, Normal Range
- V_{CC} = 2.3V to 3.6V, Extended Range
- CMOS power levels (0.4µW typ. static)
- Rail-to-Rail output swing for increased noise margin
- All inputs, outputs and I/O are 5 Volt tolerant
- Supports hot insertion

Drive Features for LVC652A:

- High Output Drivers: ±24mA
- Reduced system switching noise

APPLICATIONS:

• 5V and 3.3V mixed voltage systems
• Data communication and telecommunication systems

DESCRIPTION:

The LVC652A octal bus transceiver/register is built using advanced dual metal CMOS technology. The device consists of a bus transceiver circuit, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the data bus or from the internal storage registers.

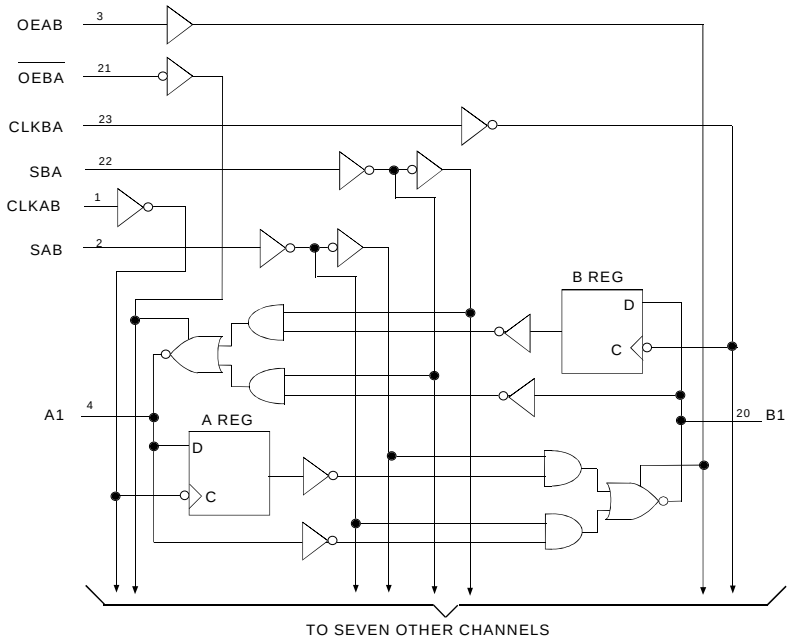
Output-enable (OEAB and $\overline{OEBA}$) inputs are provided to control the transceiver functions. Select-control (SAB and SBA) inputs are provided to select whether real-time or stored data is transferred. The circuitry used for select control eliminates the typical decoding glitch that occurs in a multiplexer during the transition between stored and real-time data. A low input selects real-time data, and a high input selects stored data.

Data on the A or B data bus, or both, is stored in the internal D-type flip-flops by low-to-high transitions at the appropriate clock (CLKAB or CLKBA) inputs, regardless of the select- or enable-control pins. When the SAB and SBA are in the real-time transfer mode, it is possible to store data without using the internal D-type flip-flops by simultaneously enabling OEAB and $\overline{OEBA}$. In this configuration, each output reinforces its input.

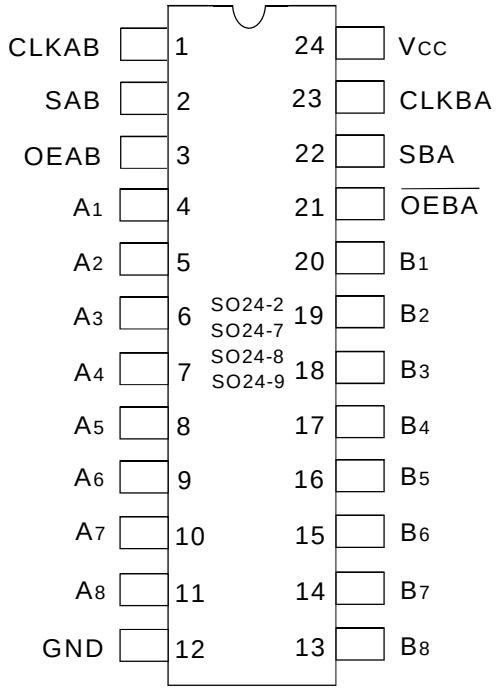
The LVC652A has been designed with a ±24mA output driver. This driver is capable of driving a moderate to heavy load while maintaining speed performance.

Inputs can be driven from either 3.3V or 5V devices. This feature allows the use of this device as a translator in a mixed 3.3V/5V system environment.

Functional Block Diagram



PIN CONFIGURATION



SOIC/ SSOP/ QSOP/ TSSOP
TOP VIEW

ABSOLUTE MAXIMUM RATINGS (1)

Symbol	Description	Max.	Unit
V_{TERM}(2)	Terminal Voltage with Respect to GND	– 0.5 to +6.5	V
V_{TERM}(3)	Terminal Voltage with Respect to GND	– 0.5 to +6.5	V
T_{STG}	Storage Temperature	– 65 to +150	°C
I_{OUT}	DC Output Current	– 50 to +50	mA
I_{IK} I_{OK}	Continuous Clamp Current, $V_I < 0$ or $V_O < 0$	– 50	mA
I_{CC} I_{SS}	Continuous Current through each V_{CC} or GND	±100	mA

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NOTES:
1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
2. V_{CC} terminals.
3. All terminals except V_{CC}.

CAPACITANCE (T_A = +25°C, f = 1.0MHz)

Symbol	Parameter(1)	Conditions	Typ.	Max.	Unit
C_{IN}	Input Capacitance	V_{IN} = 0V	4.5	6	pF
C_{OUT}	Output Capacitance	V_{OUT} = 0V	5.5	8	pF
$C_{I/O}$	I/O Port Capacitance	V_{IN} = 0V	6.5	8	pF

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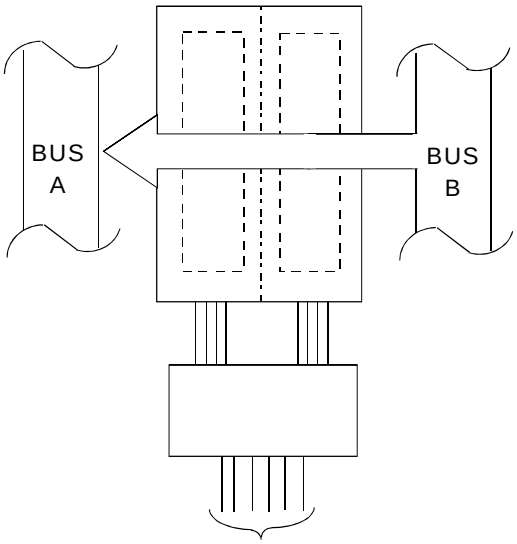
NOTE:
1. As applicable to the device type.

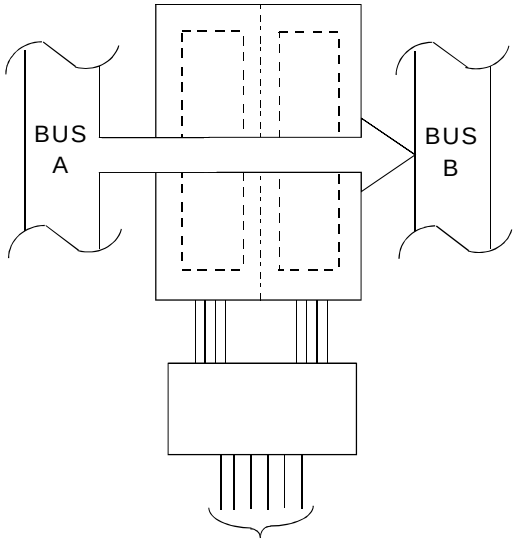
PIN DESCRIPTION

Pin Names	Description
OEAB, $\overline{OEBA}$	Output-enable Inputs
SAB, SBA	Output Data Source Select Inputs
CLKAB, CLKBA	Clock Pulse Inputs
Ax	Data Register A Inputs Data Register B Outputs
Bx	Data Register B Inputs Data Register A Outputs



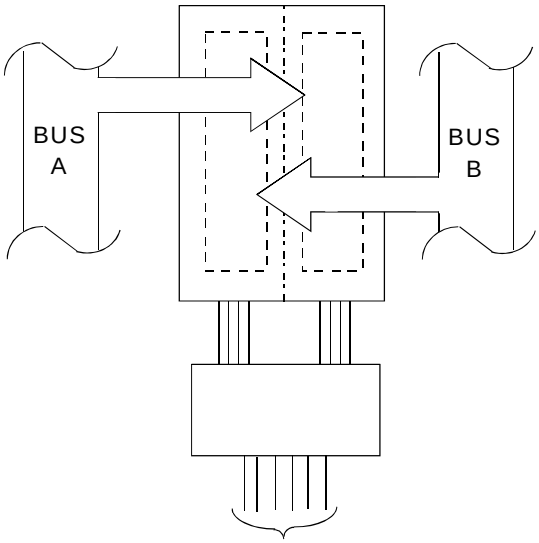
OEAB	$\overline{\text{OEBA}}$	CLKAB	CLKBA	SAB	SBA
L	L	X	X	X	L

REAL-TIME TRANSFER BUS B TO BUS A



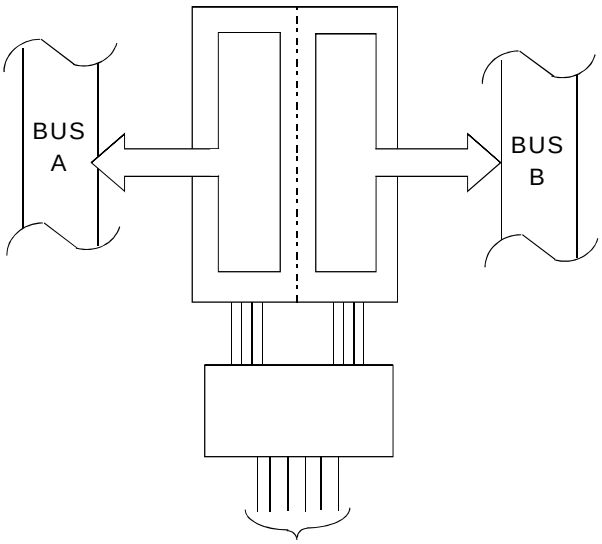
OEAB	$\overline{\text{OEBA}}$	CLKAB	CLKBA	SAB	SBA
H	H	X	X	L	X

REAL-TIME TRANSFER BUS A TO BUS B



OEAB	$\overline{\text{OEBA}}$	CLKAB	CLKBA	SAB	SBA
X	H	↑	X	X	X
L	X	X	↑	X	X
L	H	↑	↑	X	X

STORAGE FROM A, B, OR A AND B



OEAB	$\overline{\text{OEBA}}$	CLKAB	CLKBA	SAB	SBA
H	L	H or L	H or L	H	H

TRANSFER STORED DATA TO A AND/OR B

FUNCTION TABLE (1)

Inputs						Data I/O(2)		Operation or Function
OEAB	$\overline{OEBA}$	CLKAB	CLKBA	SAB	SBA	A1-A8	B1-B8	
L	H	H or L	H or L	X	X	Input	Input	Isolation
L	H	↑	↑	X	X	Input	Input	Store A and B data
X	H	↑	H or L	X	X	Input	Unspecified(3)	Store A, hold B
H	H	↑	↑	X(3)	X	Input	Output	Store A in both registers
L	X	H or L	↑	X	X	Unspecified(3)	Input	Hold A, store B
L	L	↑	↑	X	X(3)	Output	Input	Store B in both registers
L	L	X	X	X	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	X	H	Output	Input	Stored B data to A bus
H	H	X	X	L	X	Input	Output	Real-time A data to B bus
H	H	H or L	X	H	X	Input	Output	Stored A data to B bus
H	L	H or L	H or L	H	H	Output	Output	Stored A data to B bus and stored B data to A bus

NOTES:
1. H = HIGH Voltage Level
   L = LOW Voltage Level
   X = Don't care
   Z = High-Impedance
   ↑ = LOW-to-HIGH Transition
2. The data-output functions can be enabled or disabled by a variety of level combinations at OEAB or $\overline{OEBA}$. Data input functions are always enabled, i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.
3. Select control = L; clocks can occur simultaneously.
   Select control = H; clocks must be staggered to load both registers.

DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:
Operating Condition: T_A = – 40°C To +85°C

Symbol	Parameter	Test Conditions		Min.	Typ.(1)	Max.	Unit
V_{IH}	Input HIGH Voltage Level	V_{CC} = 2.3V to 2.7V		1.7	—	—	V
		V_{CC} = 2.7V to 3.6V		2	—	—	
V_{IL}	Input LOW Voltage Level	V_{CC} = 2.3V to 2.7V		—	—	0.7	V
		V_{CC} = 2.7V to 3.6V		—	—	0.8	
I_{IH} I_{IL}	Input Leakage Current	V_{CC} = 3.6V	V_I = 0 to 5.5V	—	—	±5	µA
I_{OZH} I_{OZL}	High Impedance Output Current (3-State Output pins)	V_{CC} = 3.6V	V_O = 0 to 5.5V	—	—	±10	µA
I_{OFF}	Input/Output Power Off Leakage	V_{CC} = 0V, V_{IN} or $V_O \leq$ 5.5V		—	—	±50	µA
V_{IK}	Clamp Diode Voltage	V_{CC} = 2.3V, I_{IN} = – 18mA		—	– 0.7	– 1.2	V
V_H	Input Hysteresis	V_{CC} = 3.3V		—	100	—	mV
I_{CCL} I_{CCH}	Quiescent Power Supply Current	V_{CC} = 3.6V	V_{IN} = GND or V_{CC}	—	—	10	µA
I_{CCZ}			$3.6 \leq V_{IN} \leq 5.5V$(2)	—	—	10	
ΔI_{CC}	Quiescent Power Supply Current Variation	One input at V_{CC} - 0.6V, other inputs at V_{CC} or GND		—	—	500	µA

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NOTES:
1. Typical values are at V_{CC} = 3.3V, +25°C ambient.
2. This applies in the disabled state only.

OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions[1]		Min.	Max.	Unit
V_{OH}	Output HIGH Voltage	V_{CC} = 2.3V to 3.6V	I_{OH} = – 0.1mA	V_{CC} – 0.2	—	V
		V_{CC} = 2.3V	I_{OH} = – 6mA	2	—	
		V_{CC} = 2.3V	I_{OH} = – 12mA	1.7	—	
		V_{CC} = 2.7V		2.2	—	
		V_{CC} = 3.0V		2.4	—	
		V_{CC} = 3.0V	I_{OH} = – 24mA	2.2	—	
V_{OL}	Output LOW Voltage	V_{CC} = 2.3V to 3.6V	I_{OL} = 0.1mA	—	0.2	V
		V_{CC} = 2.3V	I_{OL} = 6mA	—	0.4	
			I_{OL} = 12mA	—	0.7	
		V_{CC} = 2.7V	I_{OL} = 12mA	—	0.4	
		V_{CC} = 3.0V	I_{OL} = 24mA	—	0.55	

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NOTE:

1. V_{IH} and V_{IL} must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate V_{CC} range. T_A = – 40°C to +85°C.

OPERATING CHARACTERISTICS, V_{CC} = 3.3V ± 0.3V, T_A = 25°C

Symbol	Parameter	Test Conditions	Typical	Unit
C_{PD}	Power Dissipation Capacitance per transceiver Outputs enabled	C_L = 0pf, f = 10Mhz	84	pF
C_{PD}	Power Dissipation Capacitance per transceiver Outputs disabled		9.5	pF

SWITCHING CHARACTERISTICS [1]

		V_{CC} = 2.5±0.2V		V_{CC} = 2.7V		V_{CC} = 3.3V±0.3V		
Symbol	Parameter	Min.	Max.	Min.	Max.	Min.	Max.	Unit
f_{MAX}		—	—	80	—	100	—	MHz
t_{PLH} t_{PHL}	Propagation Delay Ax or Bx to Bx or Ax	—	—	—	7.8	1.5	7.4	ns
t_{PLH} t_{PHL}	Propagation Delay CLKAB, CLKBA to Ax or Bx	—	—	—	8.4	1.5	8	ns
t_{PLH} t_{PHL}	Propagation Delay SAB or SBA to Bx or Ax	—	—	—	9.6	1.5	8.7	ns
t_{PZH} t_{PZL}	Output Enable Time $\overline{OEBA}$ to Ax	—	—	—	8.9	1.5	7.4	ns
t_{PHZ} t_{PLZ}	Output Disable Time $\overline{OEBA}$ to Ax	—	—	—	8.1	1.5	7.5	ns
t_{PZH} t_{PZL}	Output Enable Time OEAB to Bx	—	—	—	8.6	1.5	7.1	ns
t_{PHZ} t_{PLZ}	Output Disable Time OEAB to Bx	—	—	—	7.7	1.5	7.4	ns
t_W	Pulse Duration CLKAB, CLKBA HIGH or LOW	—	—	3.3	—	3.3	—	ns
t_{SU}	Setup Time, data before CLKAB↑, CLKBA ↑	—	—	1.9	—	1.9	—	ns
t_H	Hold Time, data after CLKAB↑, CLKBA ↑	—	—	1.5	—	1.7	—	ns
$t_{SK(0)}$	Output Skew[2]	—	—	—	—	—	500	ps

NOTES:

1. See test circuits and waveforms. T_A = – 40°C to + 85°C.
2. Skew between any two outputs of the same package and switching in the same direction.

TEST CIRCUITS AND WAVEFORMS

TEST CONDITIONS

Symbol	$V_{CC}^{(1)}$= 3.3V ±0.3V	$V_{CC}^{(1)}$ = 2.7V	$V_{CC}^{(2)}$= 2.5V ±0.2V	Unit
V_{LOAD}	6	6	2 x Vcc	V
V_{IH}	2.7	2.7	Vcc	V
V_T	1.5	1.5	Vcc / 2	V
V_{LZ}	300	300	150	mV
V_{HZ}	300	300	150	mV
C_L	50	50	30	pF

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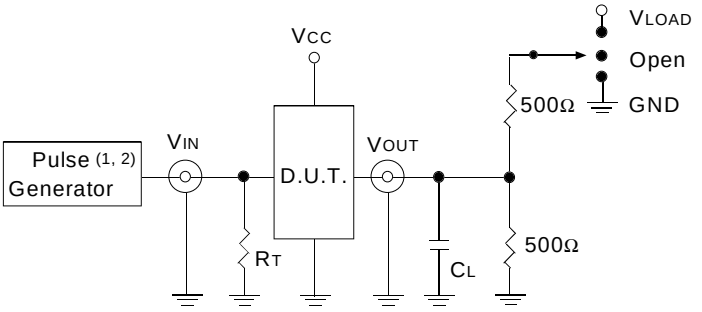
TEST CIRCUITS FOR ALL OUTPUTS



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DEFINITIONS:

C_L= Load capacitance: includes jig and probe capacitance.

R_T = Termination resistance: should be equal to Z_{OUT} of the Pulse Generator.

NOTES:

1. Pulse Generator for All Pulses: Rate ≤ 10MHz; t_F ≤ 2.5ns; t_R ≤ 2.5ns.
2. Pulse Generator for All Pulses: Rate ≤ 10MHz; t_F ≤ 2ns; t_R ≤ 2ns.

SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	V_{LOAD}
Disable High Enable High	GND
All Other tests	Open

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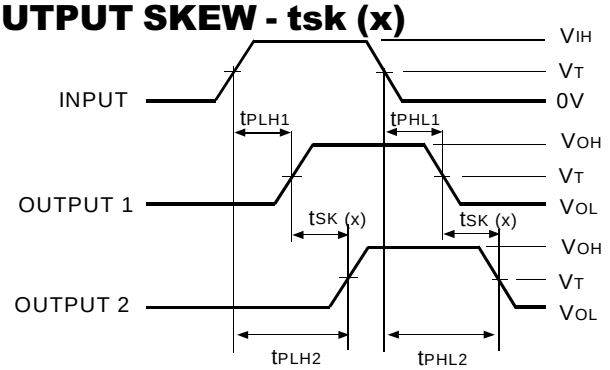
OUTPUT SKEW - tsk (x)



$t_{SK(x)} = |t_{PLH2} - t_{PLH1}|$ or $|t_{PHL2} - t_{PHL1}|$

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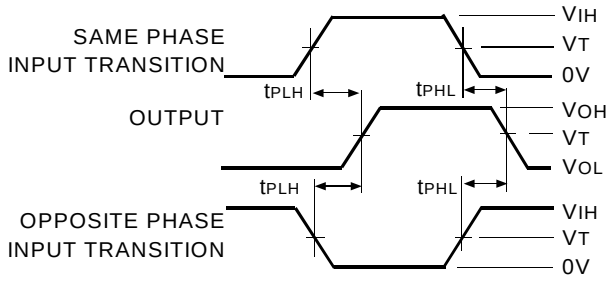
NOTES:

1. For t_{SK}(o) OUTPUT1 and OUTPUT2 are any two outputs.
2. For t_{SK}(b) OUTPUT1 and OUTPUT2 are in the same bank.

PROPAGATION DELAY



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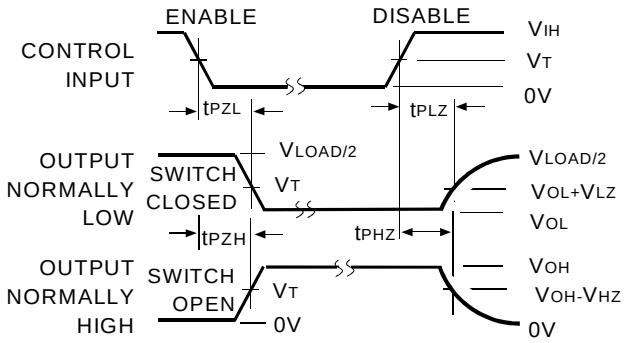
ENABLE AND DISABLE TIMES



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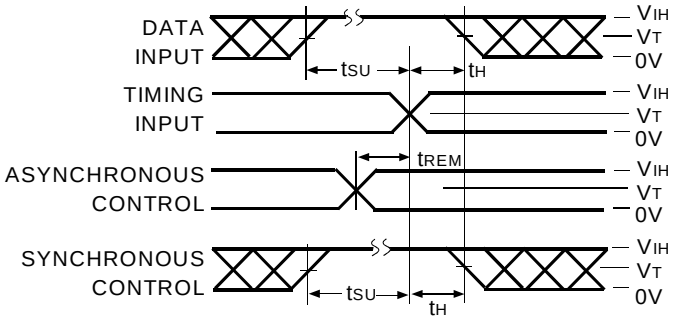
NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

SET-UP, HOLD, AND RELEASE TIMES



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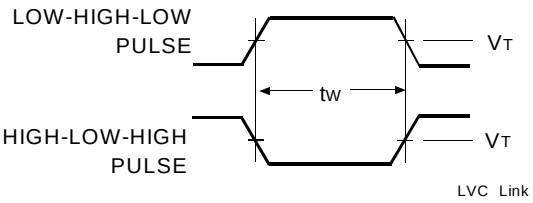
PULSE WIDTH



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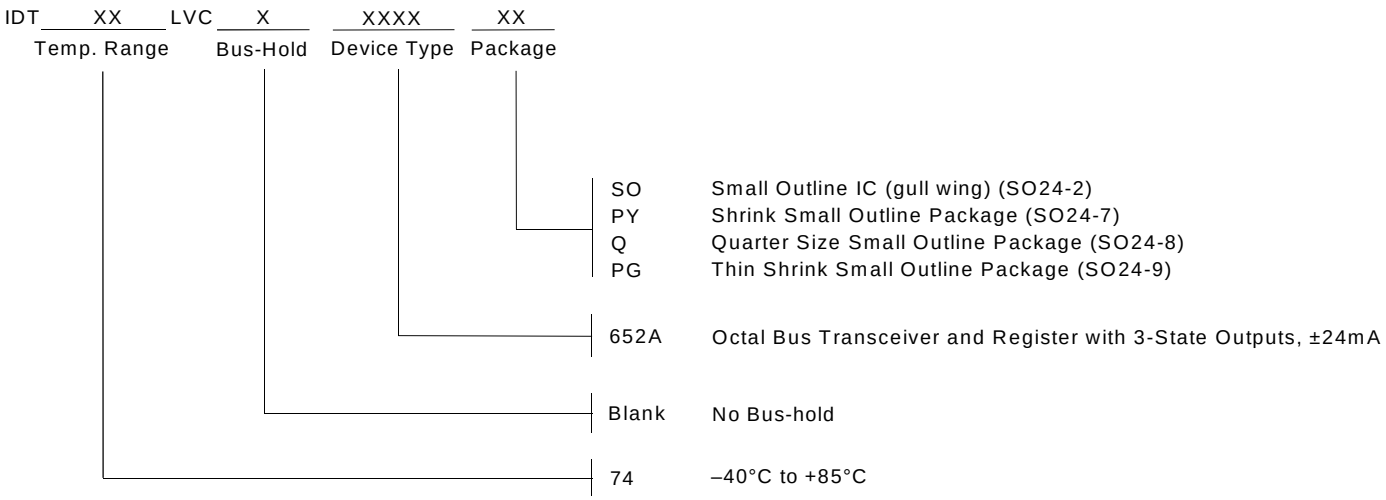
ORDERING INFORMATION



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